The Development and the commercialization of the Mask Aligner for wafer Midas System will continue to grow along with the value creation for our customers.

http://www.aligner.co.kr





The MDA-80SA is a brand new model and represents next generation of Full-field lithography systems. This brand new Semi-auto Aligner platform offers a higher Overlay Accuracy and more reliable operation. Joystick control and touch panel is more easy to access in your process.





| ITEM | SPECIFICATIONS |
|----------------------|---|
| Substrate Size | Up to 8 inch |
| UV Lamp Power | 2 kW |
| Resolution | 1μm with 1μm thin PR @ Si wafer |
| Alignment Accuracy | 1 μ m |
| Lamp Uniformity | ≤± 5% |
| Uniform Beam Size | 9,25" × 9,25" |
| 365nm Beam Intensity | 15~20mW/cm² |
| Exposure Time | $0.1\sim999.9~{ m sec}$ |
| Motorized | Microscope X, Y -axis, Zoom and Focus Stage X, Y, θ and Z-axis |
| Process mode | Vacuum, Hard, Soft and Proximity |
| Dimension | 1,500 × 1,500 × 1,900 mm |

